



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/666,399
Confirmation No. : 8955
Applicants : Michael S. Leung, et al.
Filing Date : September 18, 2003
Art Unit : 2814
Examiner : Abul Kalam
Atty. Docket No. : P0298US-7
Title : MOLDED CHIP FABRICATION METHOD AND APPARATUS

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

**AMENDMENT, RESPONSE TO FINAL OFFICE ACTION AND REQUEST FOR
CONTINUED EXAMINATION**

Sir:

In response to the Final Office Action dated September 5, 2008, please amend the above-identified application as indicated. A Request for Continued Examination has been filed concurrently with this amendment and response.

AMENDMENTS TO THE CLAIMS are reflected in the Listing of the Claims which begins on page 2 of this paper.

REMARKS begin on page 12 of this paper.